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iMOTION™ IMC100

High performance motor control IC series

IMC100

Quality Requirement Category: Industry

Feature list

- Motion Control Engine (MCE) as ready-to-use solution for variable speed drives
- Field oriented control (FOC) for permanent magnet synchronous motor (PMSM)
- Space vector PWM with sinusoidal commutation and integrated protection features
- Current sensing via single or leg shunt
- Sensorless operation
- Optional support for hall sensors (analog or digital)
- Optional boost or totem pole PFC control integrated
- Flexible host interface options for motor control commands: UART, PWM or analog input signal
- Support for IEC 60335 ('Class B')
- Integrated scripting engine for application flexibility
- Multiple package options

Applications

- Refrigerators
- Home appliances
- Pumps, fans
- ...any other PMSM drive

Ordering Information

| Product Type | Application | Package |
|--------------|--|----------|
| IMC101T-T038 | single motor | TSSOP-38 |
| IMC101T-Q048 | | QFN-48 |
| IMC101T-F048 | | TQFP-48 |
| IMC101T-F064 | | LQFP-64 |
| IMC102T-F048 | single motor + PFC (boost, totem pole) | TQFP-48 |
| IMC102T-F064 | | LQFP-64 |

Note: Variants in TQFP-48 package under development.

Description

Description

iMOTION™ IMC100 is a family of highly integrated ICs for the control of variable speed drives. By integrating both the required hardware and software to perform control of a permanent magnet synchronous motor (PMSM) they provide the shortest time to market for any motor system at the lowest system and development cost.

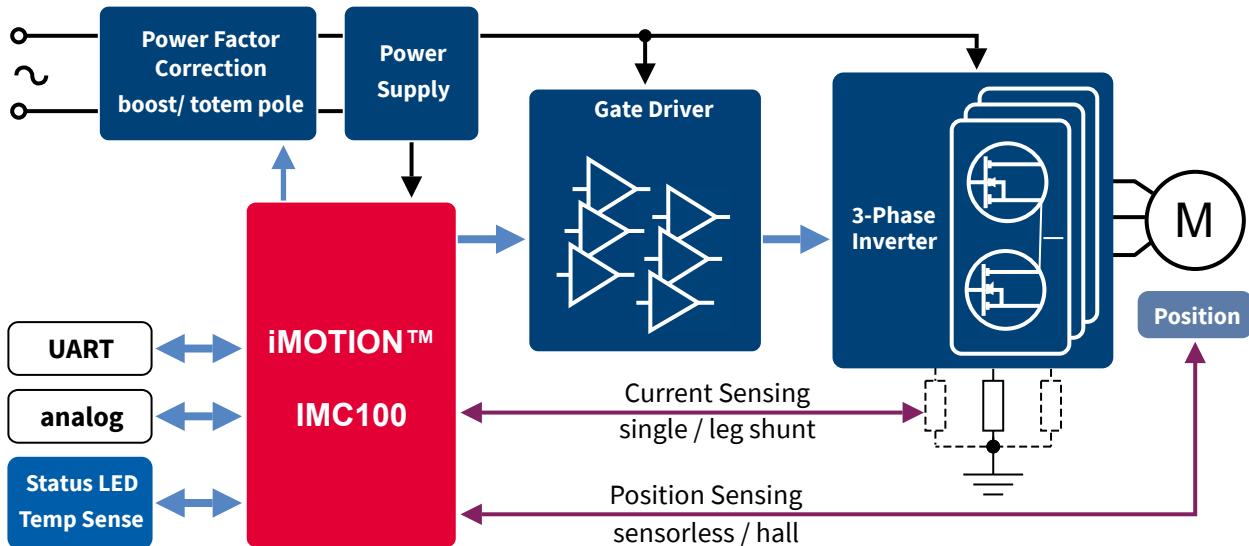


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About this document

Scope and purpose

This Datasheet describes the mechanical, electrical and functional characteristics of the iMOTION™ IMC100 series of motor control ICs. If no specific device is given the characteristics are valid for all devices within the iMOTION™ IMC100 series.

For a detailed description of the functionality and configuration options please refer to the reference manual of the Motion Control Engine.

Intended audience

The Datasheet is targeting developers implementing a variable speed drive.

Block Diagram Reference

1 Block Diagram Reference

The block diagram below gives an overview on the available functional units in the iMOTION™ IMC100 family. Not all units are required in all applications and some modules might share pins in smaller packages. Please refer to the pin configuration for the individual packages and the application schematic examples given.

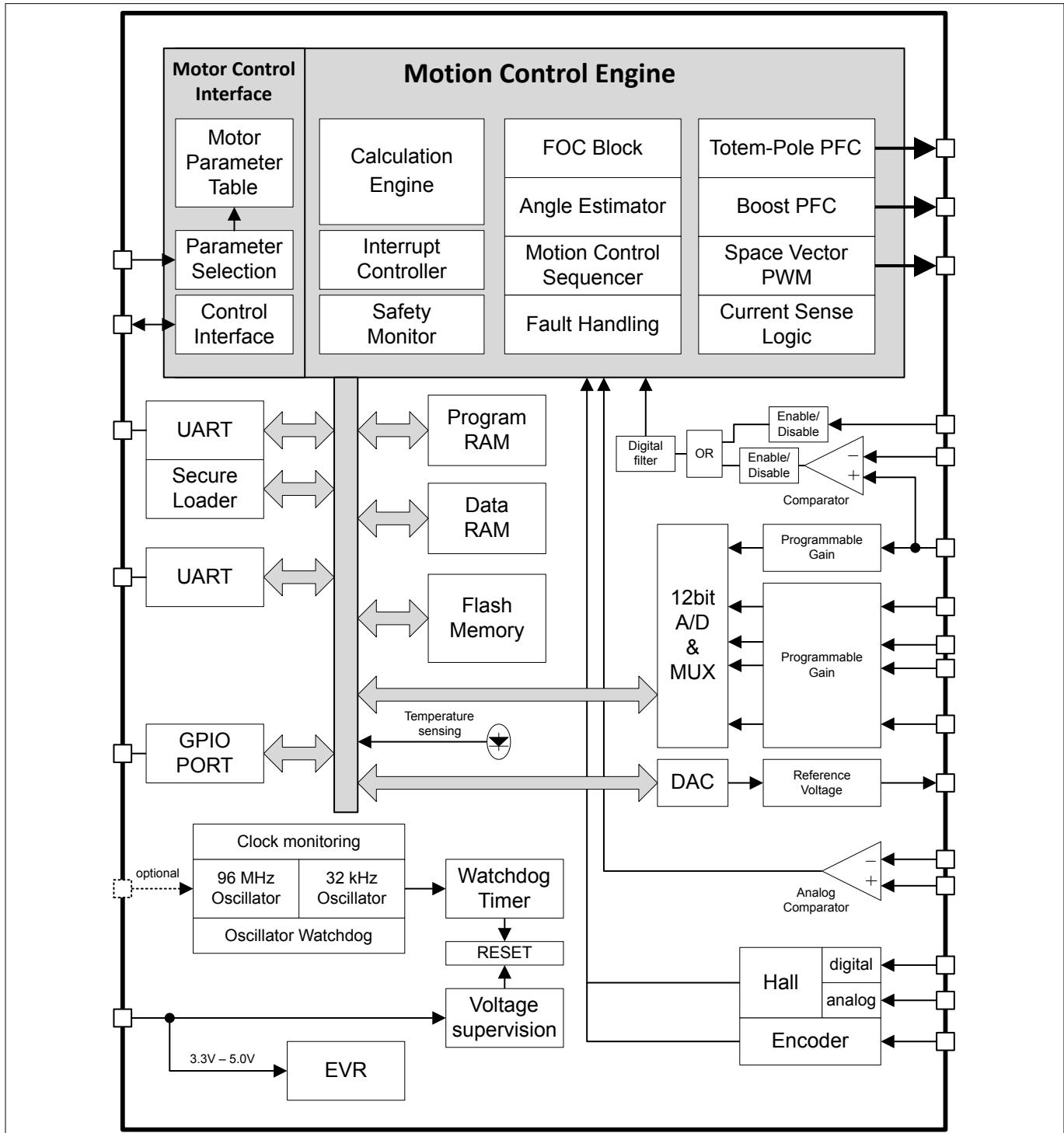


Figure 1 Block diagram

Pin Configuration

2 Pin Configuration

The following tables give the pin configurations of the individual devices of the IMC100 series in the available packages.

The pin type is specified as follows:

- I - digital input
- O - digital output
- AIN - analog input

The pin function given below refers to the standard software configuration. Different software might configure pins differently. Some of the input pins can be configured to have pull up or pull down resistor and some output pins can be configured to push-pull or open drain. This is described in the reference manual of the respective software.

Pins that do not have any signal assigned are reserved for future use. These pins should be left unconnected and neither be connected to ground nor to the positive supply.

Note: *All required reference voltages are generated by an internal DAC, therefore the pins like REFU, REFV, REFW and PFCREF only require a blocking capacitor.*

2.1 Pin Configuration IMC101T

Table 1 Pin list

| Signal | Type | LQFP-64 | VQFN-48 | TQFP-48 | TSSOP-38 | Description |
|----------------------|-------|----------------------|-------------------|-------------------|----------|--|
| Supply | | | | | | |
| VDD | Power | 2, 24, 25, 35, 50 | 18, 19, 27, 38 | 18, 19, 27, 38 | 10, 26 | Supply Voltage |
| VSS | Power | 1, 23, 49 | 17, 37 | 17, 37 | 9, 25 | Ground |
| Motor control | | | | | | |
| PWMUL | O | 29 | 21 | 21 | 11 | PWM output phase U low side |
| PWMUH | O | 30 | 22 | 22 | 12 | PWM output phase U high side |
| PWMVL | O | 31 | 23 | 23 | 13 | PWM output phase V low side |
| PWMVH | O | 32 | 24 | 24 | 14 | PWM output phase V high side |
| PWMWL | O | 33 | 25 | 25 | 15 | PWM output phase W low side |
| PWMWH | O | 34 | 26 | 26 | 16 | PWM output phase W high side |
| GK | I | 36 | 28 | 28 | 18 | Motor gate kill input |
| VDC | AIN | 14 | 8 | 8 | 2 | DC bus sensing input |
| IU/ISS | AIN | 18 | 12 | 12 | 6 | Current sense input phase U / single shunt |
| IV | AIN | 15 | 9 | 9 | 3 | Current sense input phase V / analog input |
| IW | AIN | 11 | 5 | 5 | 37 | Current sense input phase W / analog input |
| REFU | AIN | 17 | 11 | 11 | 5 | Itrip phase U reference / analog input |
| REFV | AIN | 16 | 10 | 10 | 4 | Itrip phase V reference / analog input |
| REFW | AIN | 10 | 4 | 4 | 36 | Itrip phase W reference / analog input |

Pin Configuration

Table 1 Pin list (continued)

| Signal | Type | LQFP-64 | VQFN-48 | TQFP-48 | TSSOP-38 | Description |
|---------------|------|---------|---------|---------|----------|-----------------------------------|
| Interface | | | | | | |
| DIR | I | 52 | 40 | 40 | 28 | Direction input |
| DUTYFREQ | I | 55 | 43 | 43 | 31 | Duty/Frequency input |
| VSP | AIN | 9 | 3 | 3 | 35 | Analog speed reference input |
| PGOUT | O | 42 | 30 | 30 | 21 | Pulse output |
| PARAM | AIN | 20 | 14 | 14 | 8 | Parameter table selection, analog |
| PAR0 | I | 3 | 33 | 33 | 22 | Parameter page select 0 |
| PAR1 | I | 4 | 34 | 34 | 23 | Parameter page select 1 |
| PAR2 | I | 5 | 35 | 35 | 24 | Parameter page select 2 |
| PAR3 | I | 6 | 36 | 36 | 27 | Parameter page select 3 |
| NTC | AIN | 13 | 7 | 7 | 7 | External thermistor input |
| LED | O | 41 | 29 | 29 | 17 | Status LED |
| Communication | | | | | | |
| RX0 | I | 57 | 45 | 45 | 33 | Serial port 0, receive input |
| TX0 | O | 58 | 46 | 46 | 34 | Serial port 0, transmit output |
| RX1 | I | 63 | 47 | 47 | 20 | Serial port 1, receive input |
| TX1 | O | 64 | 48 | 48 | 19 | Serial port 1, transmit output |

Pin Configuration

2.2 Pin Configuration Drawing IMC101T

The following drawings give the position of the functional pins for the available packages.

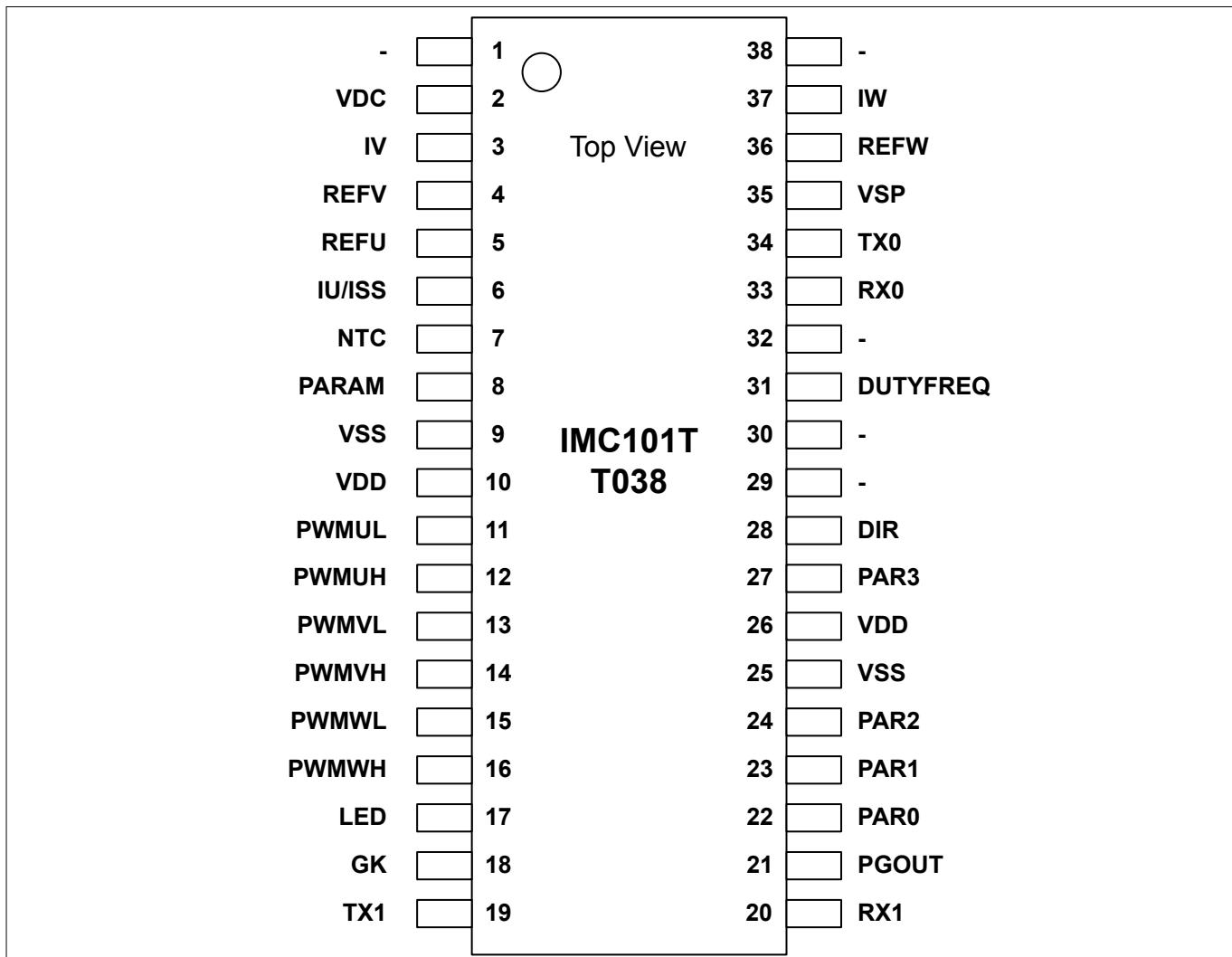


Figure 2 IMC101T-T038

Pins that do not have any signal assigned are reserved for future use. These pins should be left unconnected and neither be connected to ground nor to the positive supply.

Pin Configuration

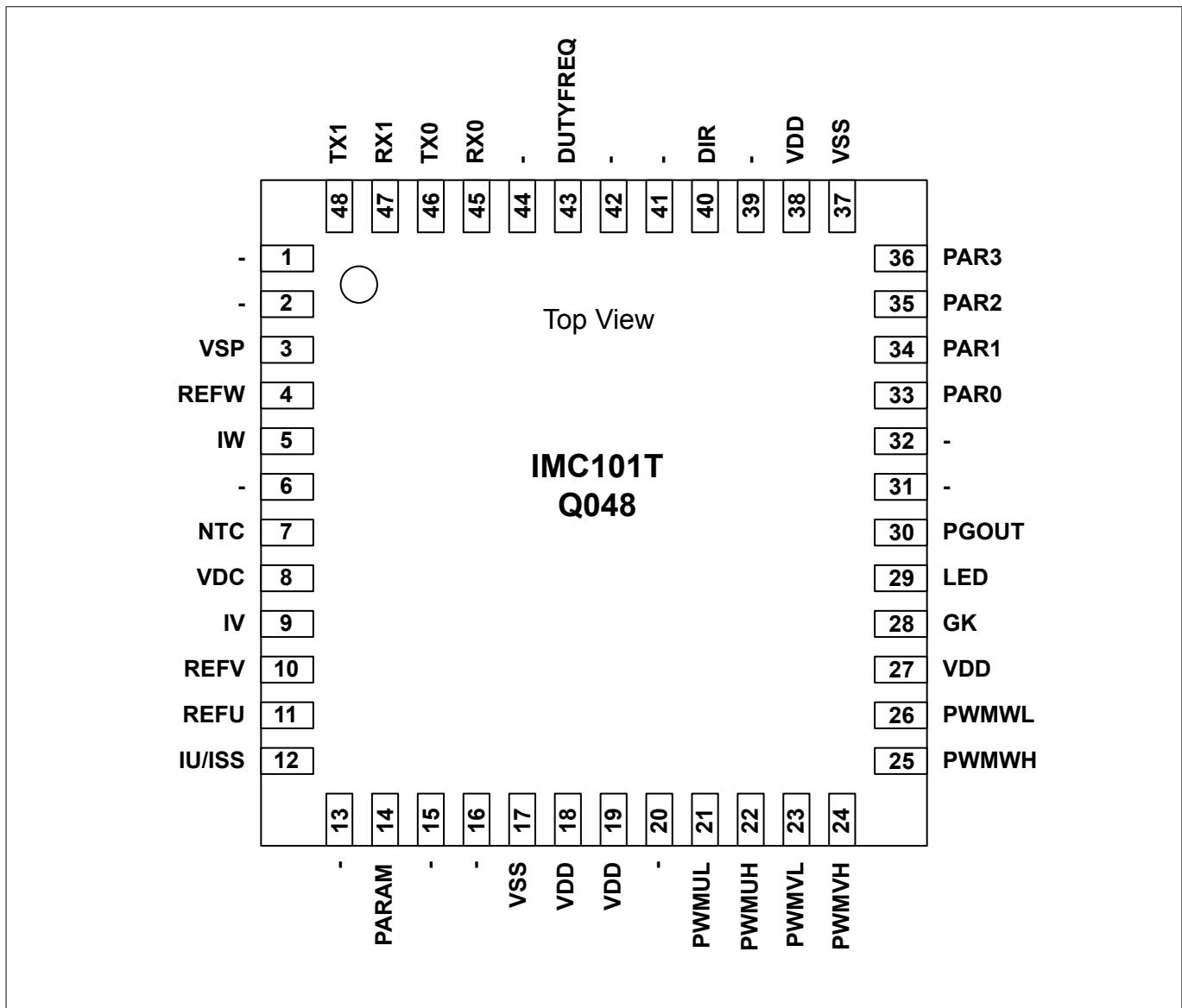


Figure 3 IMC101T-Q048

Pins that do not have any signal assigned are reserved for future use. These pins should be left unconnected and neither be connected to ground nor to the positive supply.

Pin Configuration

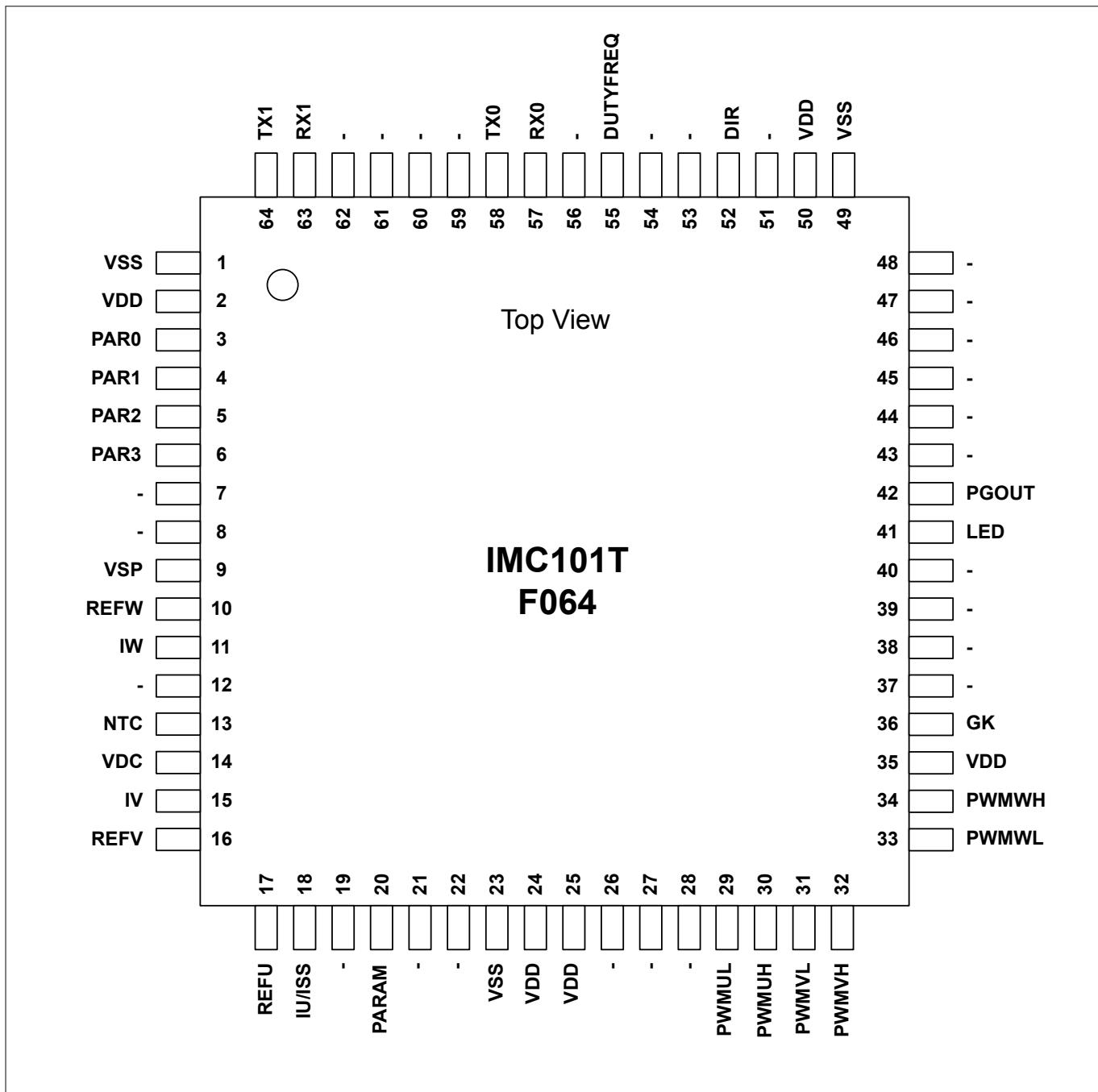


Figure 4 IMC101T-F064

Pins that do not have any signal assigned are reserved for future use. These pins should be left unconnected and neither be connected to ground nor to the positive supply.

Pin Configuration

2.3 Pin Configuration IMC102T

Table 2 Pin list

| Signal | Type | LQFP-64 | TQFP-48 | Description |
|-------------------------|-------|----------------------|-------------------|---|
| Supply | | | | |
| VDD | Power | 2, 24, 25, 35, 50 | 18, 19, 27, 38 | Supply Voltage |
| VSS | Power | 1, 23, 49 | 17, 37 | Ground |
| Motor control | | | | |
| PWMUL | O | 29 | 21 | PWM output phase U low side |
| PWMUH | O | 30 | 22 | PWM output phase U high side |
| PWMVL | O | 31 | 23 | PWM output phase V low side |
| PWMVH | O | 32 | 24 | PWM output phase V high side |
| PWMWL | O | 33 | 25 | PWM output phase W low side |
| PWMWH | O | 34 | 26 | PWM output phase W high side |
| GK | I | 36 | 28 | Motor gate kill input |
| VDC | AIN | 14 | 8 | DC bus sensing input |
| IU/ISS | AIN | 18 | 12 | Current sense input phase U / single shunt |
| IV | AIN | 15 | 9 | Current sense input phase V / analog input |
| IW | AIN | 11 | 5 | Current sense input phase W / analog input |
| REFU | AIN | 17 | 11 | Itrip phase U reference / analog input |
| REFV | AIN | 16 | 10 | Itrip phase V reference / analog input |
| REFW | AIN | 10 | 4 | Itrip phase W reference / analog input |
| Power factor correction | | | | |
| PFCG0 | O | 44 | 31 | PFC gate drive 0 |
| PFCG1 | O | 43 | 32 | PFC gate drive 1 (totem pole only - high side switch) |
| PFCI | AIN | 12 | 6 | PFC current sensing |
| PFCREF | AIN | 21 | 15 | Itrip PFC reference input |
| PFCITRIP | AIN | 22 | 16 | Itrip PFC input |
| VAC1 | AIN | 20 | 14 | VAC sense input line 1 |
| VAC2 | AIN | 19 | 13 | VAC sense input line 2 |
| Interface | | | | |
| DIR | I | 52 | 40 | Direction input |
| DUTYFREQ | I | 55 | 43 | Duty/Frequency input |
| VSP | AIN | 9 | 3 | Analog speed reference input |
| PGOUT | O | 42 | 30 | Pulse output |
| PAR0 | I | 3 | 33 | Parameter page select 0 |
| PAR1 | I | 4 | 34 | Parameter page select 1 |

Pin Configuration

Table 2 Pin list (continued)

| Signal | Type | LQFP-64 | TQFP-48 | Description |
|--------|------|---------|---------|---------------------------|
| PAR2 | I | 5 | 35 | Parameter page select 2 |
| PAR3 | I | 6 | 36 | Parameter page select 3 |
| NTC | AIN | 13 | 7 | External thermistor input |
| LED | O | 41 | 29 | Status LED |

Communication

| | | | | |
|-----|---|----|----|--------------------------------|
| RX0 | I | 57 | 45 | Serial port 0, receive input |
| TX0 | O | 58 | 46 | Serial port 0, transmit output |
| RX1 | I | 63 | 47 | Serial port 1, receive input |
| TX1 | O | 64 | 48 | Serial port 1, transmit output |

Pin Configuration

2.4 Pin Configuration Drawing IMC102T

The following drawings give the position of the functional pins for the available packages.

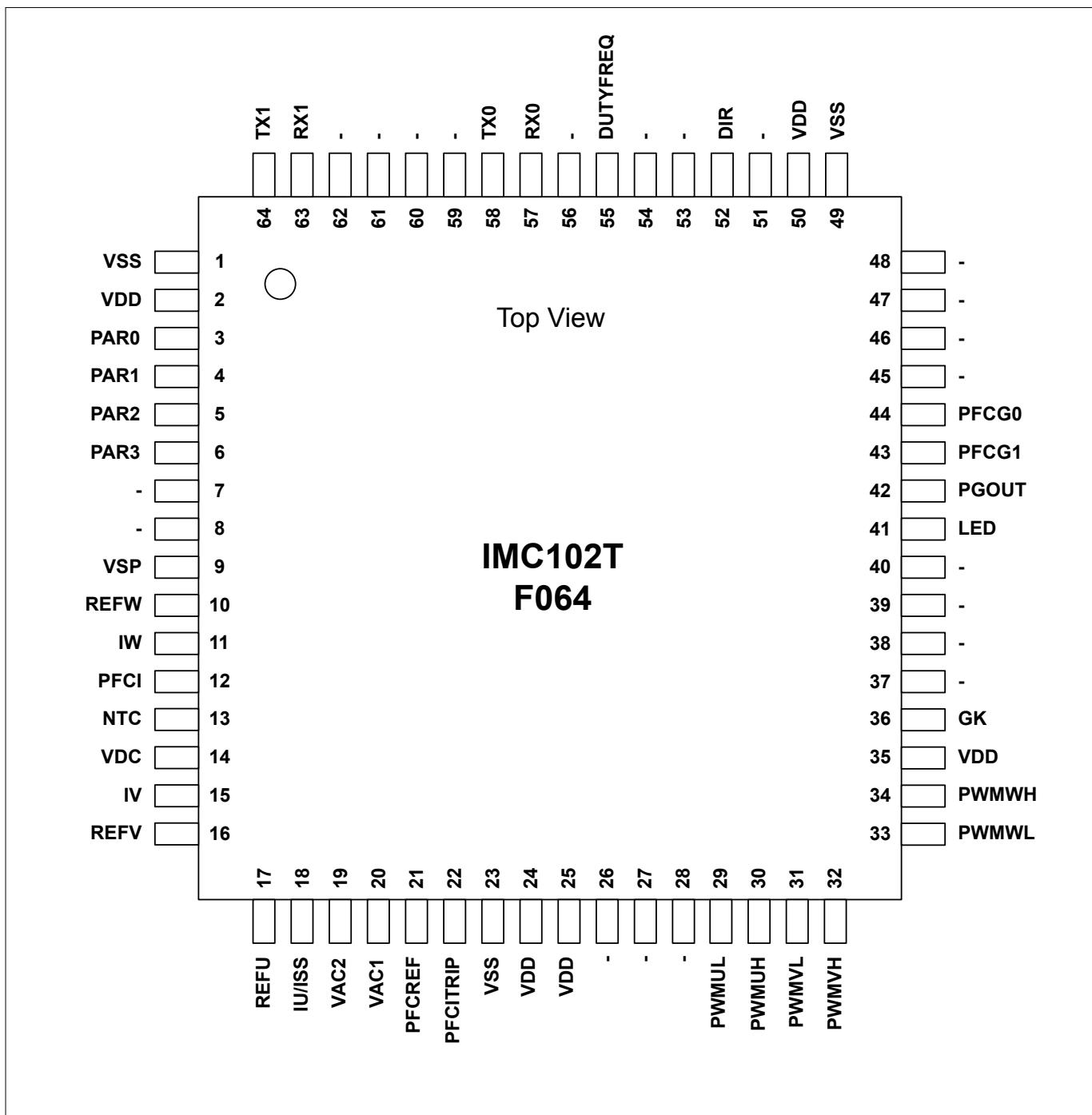


Figure 5 IMC102T-F064

Pins that do not have any signal assigned are reserved for future use. These pins should be left unconnected and neither be connected to ground nor to the positive supply.

Functional description

3 Functional description

iMOTION™ IMC100 is a series of highly integrated ICs for the control of a Permanent Magnet Synchronous Motor (PMSM). IMC101 devices provide control of a single motor while the IMC102 devices control the motor and additionally a boost or totem pole power factor correction (PFC).

The IMC100 series is based on Infineon's Motion Control Engine (MCE) and integrate all hardware and software functions required to implement a closed loop sensorless (or optionally sensor based) control algorithm for permanent magnet motors. IMC100 devices do not require any software programming and can be configured for a wide range of motor control inverters.

The IMC100 series takes advantage of a new hardware platform that is based on a comprehensive set of innovative analog and motor control peripherals. The high level of integration both in terms of hardware modules and software algorithms results in a minimum number of external components required for the implementation of the inverter control.

Infineon's patented and field proven Motion Control Engine (MCE) implements field oriented control (FOC) using single or leg shunt current feedback and uses space vector pulse width modulation (PWM) with sinusoidal signals to achieve highest energy efficiency. In addition to the motor control algorithm it also integrates multiple configurable protection features like over- and under-voltage, over current, rotor lock etc. to protect both the power stage as well as the motor during application tuning or in case of malfunction.

The second generation of the MCE further improves the performance of the sensorless control algorithm and adds functionality like optional sensor support for applications that require accurate rotor positioning, two types of ready-to-use PFC algorithms as well as more and flexible and faster host interface options.

The IMC100 series is offered in several device and package variants for applications from single motor control to motor control plus PFC. All devices can be used in applications requiring functional safety according to IEC 60335 ('Class B').

There are multiple versions of the MCE software offered by Infineon and made available for download from the Infineon web site.

By using a special secure boot loader algorithm in combination with type specific chip IDs it is assured that these MCE software versions can only be installed onto the matching hardware derivatives, i.e. IMC100 variants for which the software has been tested and released for. Infineon provides the tools to program these software images for download from the website.

This data sheet provides all electrical, mechanical, thermal and quality parameters. A detailed description of the features, functionality and configuration of the Motion Control Engine (MCE) can be found in the respective reference manual of the MCE.

The application schematics in the following chapters show some examples of different use cases for the IMC100 devices. The combination of the different configuration options like leg vs. single shunt, sensorless or sensored operation, boost or totem pole PFC etc. is not limited to the examples shown here but can be chosen according to the individual application requirements.

Functional description

3.1 Application schematic motor control single shunt

Figure 6 gives the schematic diagram for a motor control system using the IMC101 in sensorless operation and single shunt mode.

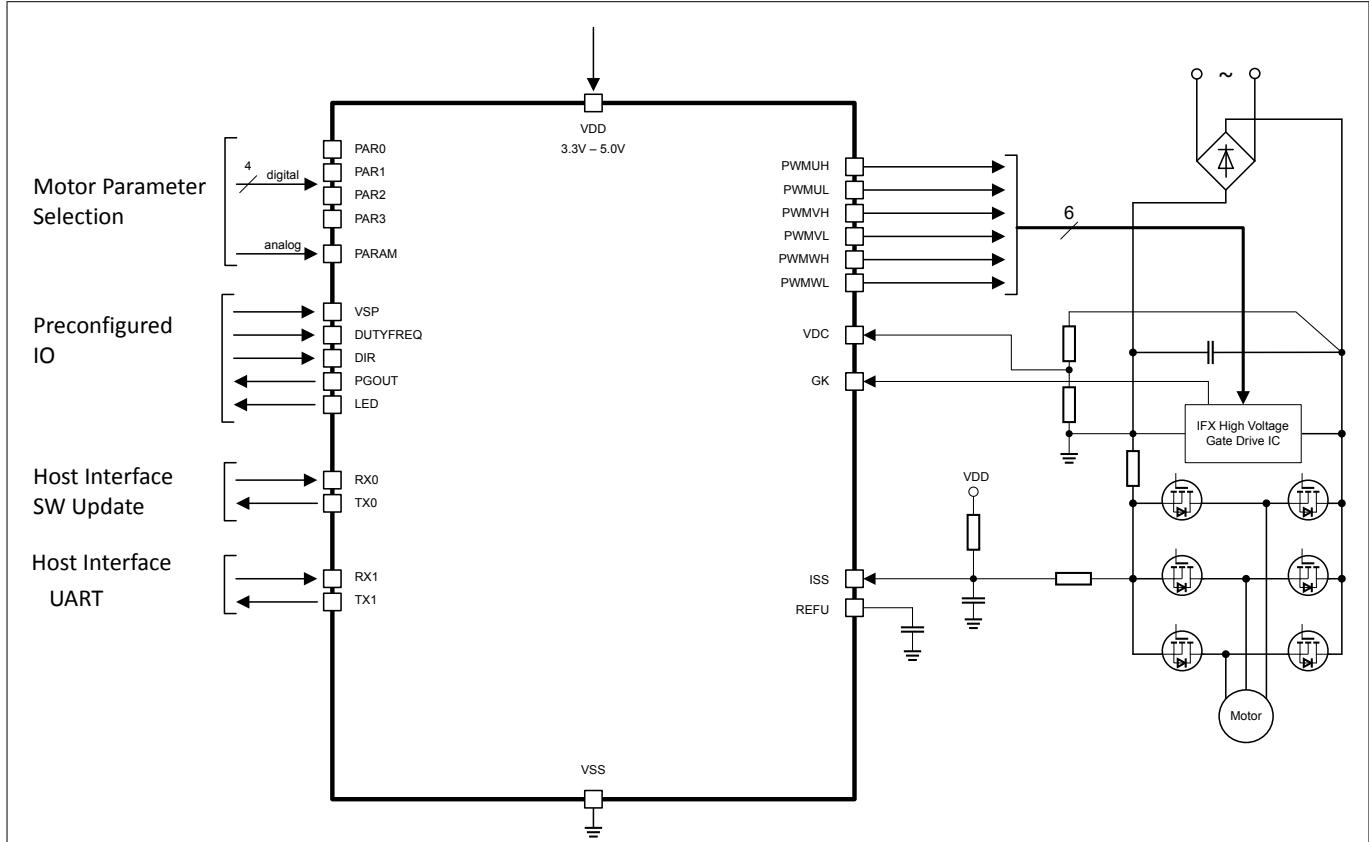


Figure 6 IMC101 in single shunt configuration

Functional description

3.2 Application schematic motor control leg shunt

Figure 7 gives the schematic diagram for a motor control system using the IMC101 in sensorless operation and leg shunt mode.

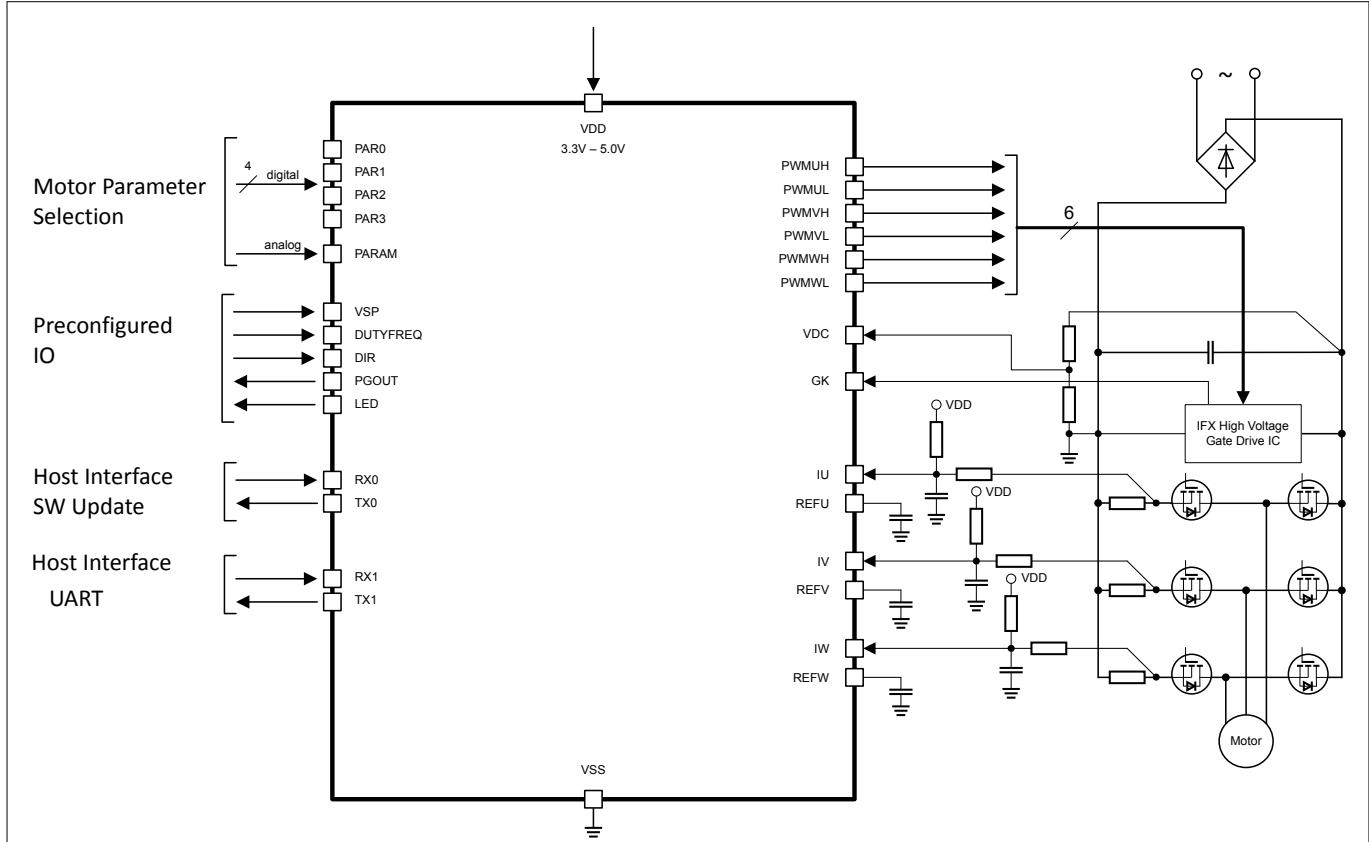


Figure 7 IMC101 in leg shunt configuration

Functional description

3.3 Application schematic motor control plus boost PFC

Figure 8 gives the schematic diagram for a motor control system with boost PFC using the IMC102 in sensorless operation and single shunt mode.

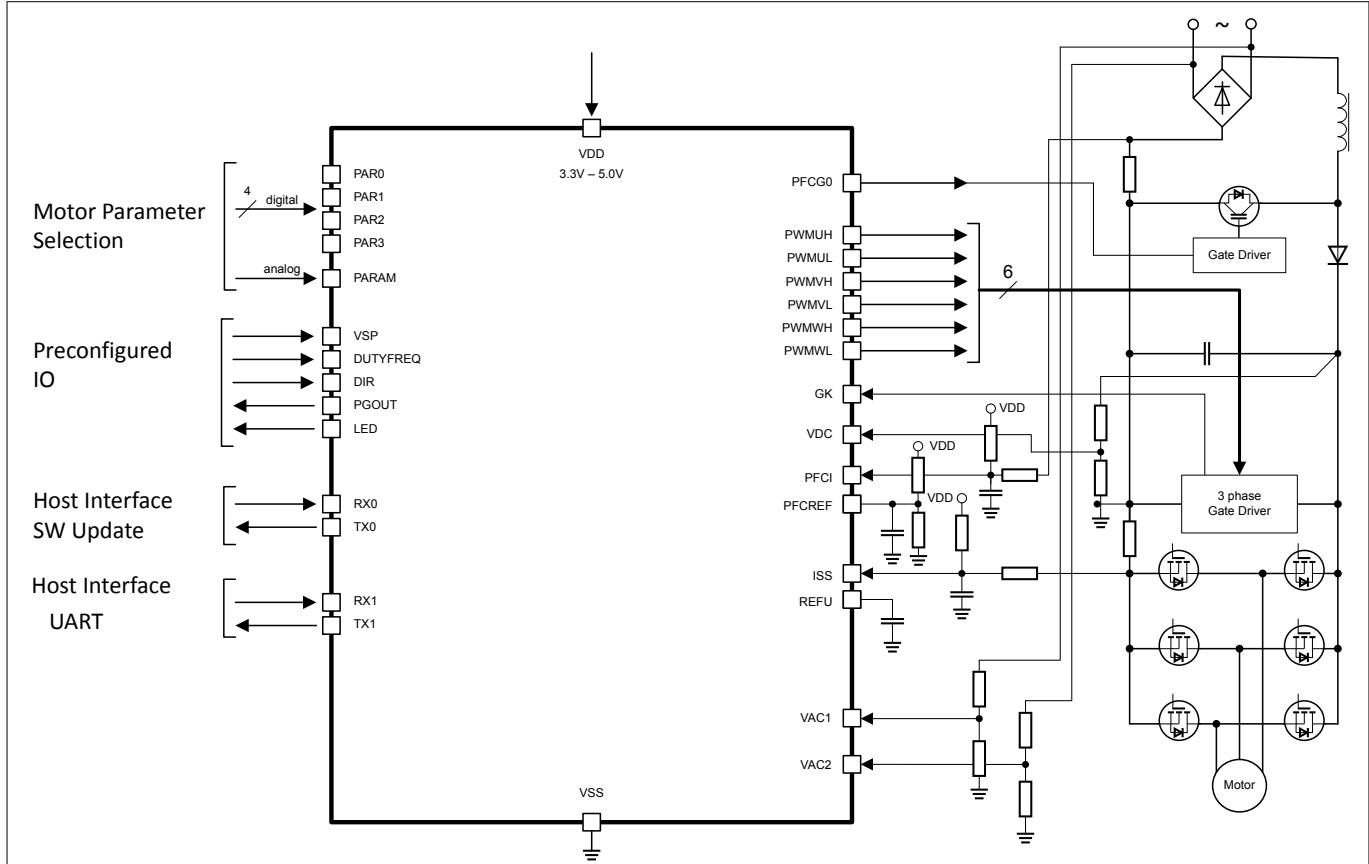


Figure 8 IMC102 in single shunt configuration with boost PFC control

Functional description

3.4 Application schematic motor control plus totem pole PFC

Figure 9 gives the schematic diagram for a motor control system with totem pole PFC using the IMC102 in sensorless operation and single shunt mode.

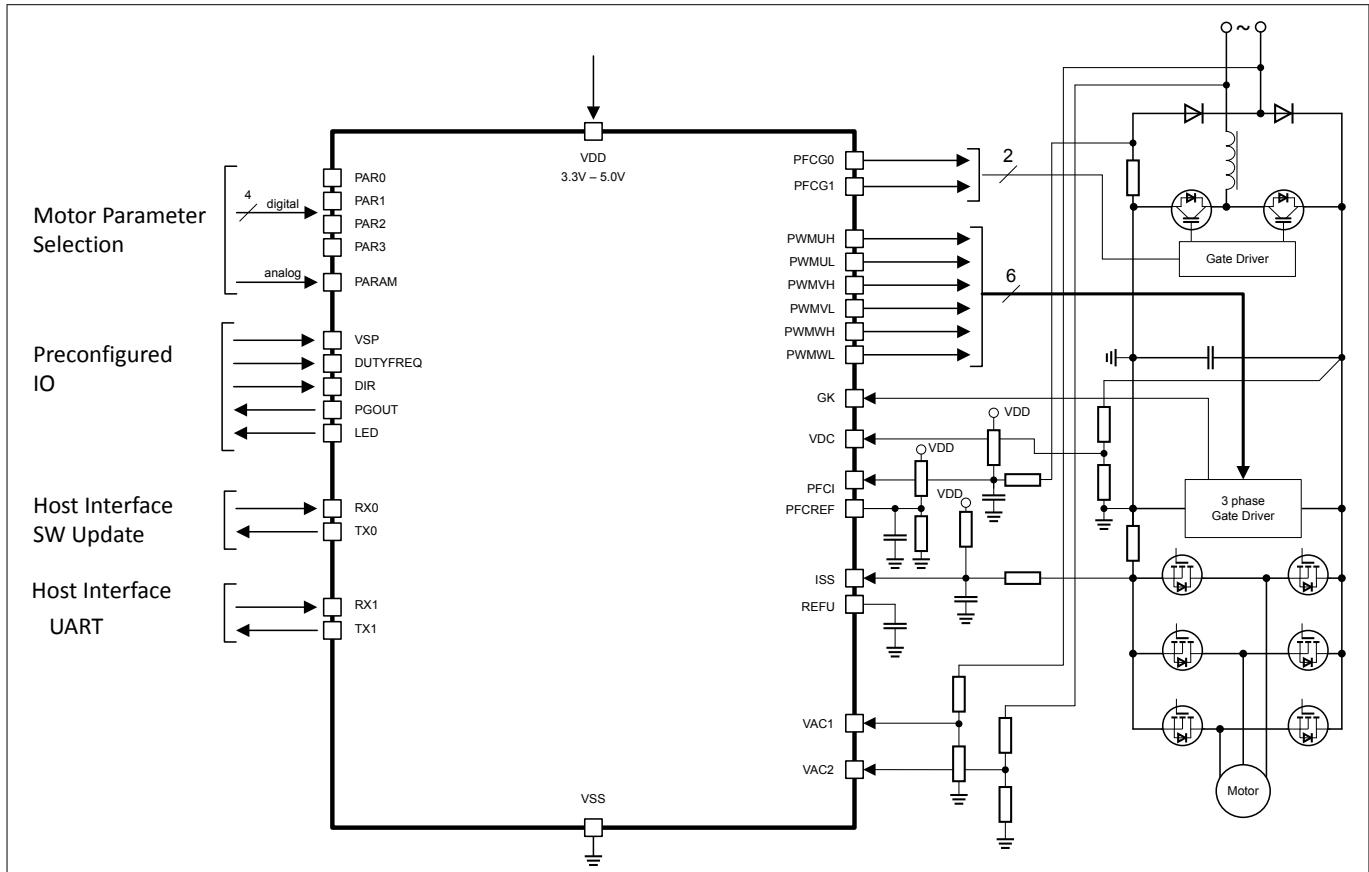


Figure 9 IMC102 in single shunt configuration with totem pole PFC

Electrical characteristics and parameters

4 Electrical characteristics and parameters

4.1 General Parameters

4.1.1 Parameter Interpretation

The parameters listed in this section represent partly the characteristics of the IMC100 and partly its requirements on the system. To aid interpreting the parameters easily when evaluating them for a design, they are indicated by the abbreviations in the “Symbol” column:

- CC**

Such parameters indicate **Controller Characteristics**, which are distinctive feature of the IMC100 and must be regarded for a system design.

- SR**

Such parameters indicate **System Requirements**, which must be provided by the application system in which the IMC100 is designed in.

4.1.2 Absolute Maximum Ratings

Stresses above the values listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Table 3 Absolute Maximum Rating Parameters

| Parameter | Symbol | Values | | | Unit | Note or Test Condition |
|--|----------------------------|--------|------|---------------------------|------|------------------------|
| | | Min. | Typ. | Max. | | |
| Ambient temperature | T_A SR | -40 | - | 105 | °C | - |
| Junction temperature | T_J SR | -40 | - | 115 | °C | - |
| Storage temperature | T_{ST} SR | -55 | - | 125 | °C | - |
| Voltage on power supply pin with respect to V_{SSP} | V_{DDP} SR | -0.3 | - | 6 | V | - |
| Voltage on digital pins with respect to V_{SSP} | V_{IN} SR | -0.3 | - | $V_{DDP} + 0.3$ or max. 6 | V | whichever is lower |
| Voltage on analog input pins with respect to V_{SSP} | V_{AIN} V_{AREF} SR | -0.5 | - | $V_{DDP} + 0.5$ or max. 6 | V | whichever is lower |
| Input current on any pin during overload condition | I_{IN} SR | -10 | - | 10 | mA | - |
| Absolute maximum sum of all input currents during overload condition | ΣI_{IN} SR | -50 | - | +50 | mA | - |

Electrical characteristics and parameters

4.1.3 Pin Reliability in Overload

When receiving signals from higher voltage devices, low-voltage devices experience overload currents and voltages that go beyond their own IO power supplies specification.

Table 4 defines overload conditions that will not cause any negative reliability impact if all the following conditions are met:

- full operation life-time is not exceeded
- **Operating Conditions** are met for
 - pad supply levels (V_{DDP})
 - temperature

If a pin current is outside of the **Operating Conditions** but within the overload conditions, then the parameters of this pin as stated in the Operating Conditions can no longer be guaranteed. Operation is still possible in most cases but with relaxed parameters.

Note: *An overload condition on one or more pins does not require a reset.*

Note: *A series resistor at the pin to limit the current to the maximum permitted overload current is sufficient to handle failure situations like short to battery.*

Table 4 Overload Parameters

| Parameter | Symbol | Values | | | Unit | Note or Test Condition |
|--|--------------|--------|------|------|------|------------------------|
| | | Min. | Typ. | Max. | | |
| Input current on analog port pins during overload condition | I_{OVA} SR | -3 | - | 3 | mA | |
| Input current on any port pin during overload condition | I_{OV} SR | -5 | - | 5 | mA | |
| Absolute sum of all input circuit currents during overload condition | I_{OVS} SR | - | - | 25 | mA | |

Electrical characteristics and parameters

Figure 10 shows the path of the input currents during overload via the ESD protection structures. The diodes against V_{DDP} and ground are a simplified representation of these ESD protection structures.

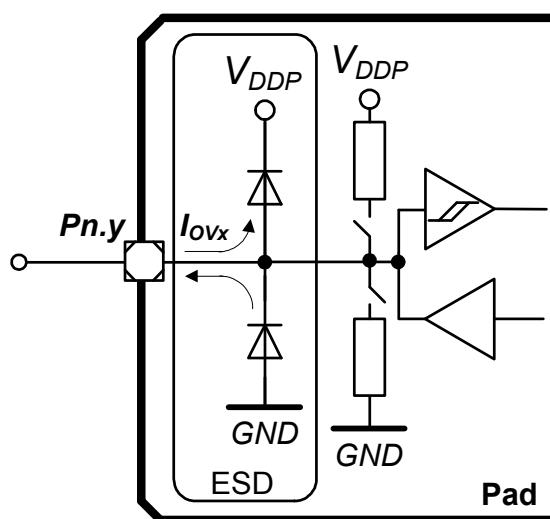


Figure 10 Input Overload Current via ESD structures

Table 5 and **Table 6** list input voltages that can be reached under overload conditions. Note that the absolute maximum input voltages as defined in the **Absolute Maximum Ratings** must not be exceeded during overload.

Table 5 PN-Junction Characteristics for positive Overload

| Pad Type | $I_{OV} = 5 \text{ mA}$ |
|--------------------------------------|---|
| Standard, High-current, AN/DIG_IN | $V_{IN} = V_{DDP} + (0.3 \dots 0.5) \text{ V}$ $V_{AIN} = V_{DDP} + 0.5 \text{ V}$ $V_{AREF} = V_{DDP} + 0.5 \text{ V}$ |

Table 6 PN-Junction Characteristics for negative Overload

| Pad Type | $I_{OV} = 5 \text{ mA}$ |
|--------------------------------------|--|
| Standard, High-current, AN/DIG_IN | $V_{IN} = V_{SS} - (0.3 \dots 0.5) \text{ V}$ $V_{AIN} = V_{SS} - 0.5 \text{ V}$ $V_{AREF} = V_{SS} - 0.5 \text{ V}$ |

Electrical characteristics and parameters

4.1.4 Operating Conditions

The following operating conditions must not be exceeded in order to ensure correct operation and reliability of the IMC100. All parameters specified in the following tables refer to these operating conditions, unless noted otherwise.

Table 7 Operating Conditions Parameters

| Parameter | Symbol | Values | | | Unit | Note or Test Condition |
|--|-----------------------|--------|------|------|------|------------------------|
| | | Min. | Typ. | Max. | | |
| Ambient Temperature | T_A SR | -40 | - | 105 | °C | |
| Junction temperature | T_J SR | -40 | - | 115 | °C | |
| Digital supply voltage ¹⁾ | V_{DDP} SR | 3.0 | 3.3 | 5.5 | V | |
| Short circuit current of digital outputs ²⁾ | I_{SC} SR | -5 | - | 5 | mA | |
| Absolute sum of short circuit currents of the device ³⁾ | ΣI_{SC_D} SR | - | - | 25 | mA | |

¹ See also the Supply Monitoring thresholds [Power-Up and Supply Threshold Characteristics](#).

² Applicable for digital outputs.

³ See also section "Pin Reliability in Overload" for overload current definitions.

Electrical characteristics and parameters

4.2 DC Parameters

4.2.1 Input/Output Characteristics

The table below provides the characteristics of the input/output pins of the IMC100.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Note: Unless otherwise stated, input DC and AC characteristics, including peripheral timings, assume that the input pads operate with the standard hysteresis.

Table 8 Input/Output Characteristics (Operating Conditions apply)

| Parameter | Symbol | CC | Limit Values | | Unit | Test Conditions |
|---|----------------------------|----|------------------|------|------|--|
| | | | Min. | Max. | | |
| Output low voltage on port pins | V_{OLP} | CC | - | 1.0 | V | $I_{OL} = 11 \text{ mA (5 V)}$ $I_{OL} = 7 \text{ mA (3.3 V)}$ |
| | | | - | 0.4 | V | $I_{OL} = 5 \text{ mA (5 V)}$ $I_{OL} = 3.5 \text{ mA (3.3 V)}$ |
| Output low voltage on PWM outputs | V_{OLP1} | CC | - | 1.0 | V | $I_{OL} = 50 \text{ mA (5 V)}$ $I_{OL} = 25 \text{ mA (3.3 V)}$ |
| | | | - | 0.32 | V | $I_{OL} = 10 \text{ mA (5 V)}$ |
| | | | - | 0.4 | V | $I_{OL} = 5 \text{ mA (3.3 V)}$ |
| Output high voltage on port pins | V_{OHP} | CC | $V_{DDP} - 1.0$ | - | V | $I_{OH} = -10 \text{ mA (5 V)}$ $I_{OH} = -7 \text{ mA (3.3 V)}$ |
| | | | $V_{DDP} - 0.4$ | - | V | $I_{OH} = -4.5 \text{ mA (5 V)}$ $I_{OH} = -2.5 \text{ mA (3.3 V)}$ |
| Output high voltage on PWM outputs | V_{OHP1} | CC | $V_{DDP} - 0.32$ | - | V | $I_{OH} = -6 \text{ mA (5 V)}$ |
| | | | $V_{DDP} - 1.0$ | - | V | $I_{OH} = -8 \text{ mA (3.3 V)}$ |
| | | | $V_{DDP} - 0.4$ | - | V | $I_{OH} = -4 \text{ mA (3.3 V)}$ |
| Rise/fall time on PWM outputs ⁴⁾ | t_{HCPR} , t_{HCPF} | CC | - | 9 | ns | 50 pF @ 5 V |
| | | | - | 12 | ns | 50 pF @ 3.3 V |
| Rise/fall time on standard pad | t_R, t_F | CC | - | 12 | ns | 50 pF @ 5 V |
| | | | - | 15 | ns | 50 pF @ 3.3 V. |
| Pin capacitance (digital inputs/outputs) | C_{IO} | CC | - | 10 | pF | |
| Pull-up/-down resistor on port pins (if enabled in software) | R_{PUP} | CC | 20 | 50 | kΩ | $V_{IN} = V_{SSP}$ |

⁴ Rise/Fall time parameters are taken with 10% - 90% of supply.

Electrical characteristics and parameters

Table 8 Input/Output Characteristics (Operating Conditions apply) (continued)

| Parameter | Symbol | Limit Values | | Unit | Test Conditions | |
|--|-----------------------|---------------------|-------------|-------------|------------------------|---|
| | | Min. | Max. | | | |
| Input leakage current ⁵⁾ | I_{OZP} | CC | -1 | 1 | μA | $0 < V_{IN} < V_{DDP}$, $T_A 105^\circ C$ |
| Maximum current per pin standard pin | I_{MP} | SR | -10 | 11 | mA | - |
| Maximum current per PWM outputs pins | I_{MP1A} | SR | -10 | 50 | mA | - |
| Maximum current into V_{DDP} / out of V_{SS} | I_{MVDD} / I_{MVSS} | SR | - | 260 | mA | |

⁵ An additional error current (I_{INJ}) will flow if an overload current flows through an adjacent pin.

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4.2.2 Analog to Digital Converter (ADC)

The following table shows the Analog to Digital Converter (ADC) characteristics. This specification applies to all analog input as given in the pin configuration list.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 9 ADC Characteristics (Operating Conditions apply)⁶⁾

| Parameter | Symbol | Values | | | Unit | Note or Test Condition |
|--|------------------|------------------|------|------------------|-------|------------------------|
| | | Min. | Typ. | Max. | | |
| Supply voltage range | $V_{DD\ SR}$ | 3.0 | – | 5.5 | V | |
| Analog input voltage range | $V_{AIN\ SR}$ | $V_{SSP} - 0.05$ | – | $V_{DDP} + 0.05$ | V | |
| Conversion time | $t_{C12\ CC}$ | – | 1.0 | 1.6 | μs | |
| Total capacitance of an analog input | $C_{AINT\ CC}$ | – | – | 10 | pF | |
| Total capacitance of the reference input | $C_{AREFT\ CC}$ | – | – | 10 | pF | |
| Sample time | $t_{sample\ CC}$ | – | 200 | – | ns | |
| RMS noise | $EN_{RMS\ CC}$ | – | 1.5 | – | LSB12 | |
| DNL error | $EA_{DNL\ CC}$ | – | ±2.0 | – | LSB12 | |
| INL error | $EA_{INL\ CC}$ | – | ±4.0 | – | LSB12 | |
| Gain error | $EA_{GAIN\ CC}$ | – | ±0.5 | – | % | $V_{DD} = 3.3V$ |
| Offset error | $EA_{OFF\ CC}$ | – | ±8.0 | – | mV | |

⁶ All parameters are defined for the full supply range if not stated otherwise.